

www.vishay.com

Vishay General Semiconductor

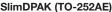
COMPLIANT

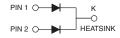
HALOGEN

**FREE** 

# **Surface-Mount ESD Capability Rectifier**







PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	2 x 3 A				
$V_{RRM}$	100 V, 200 V, 400 V, 600 V				
I <sub>FSM</sub>	42 A				
V <sub>F</sub> at I <sub>F</sub> = 3 A (T <sub>A</sub> = 125 °C)	0.94 V				
T <sub>J</sub> max.	175 °C				
Package	SlimDPAK (TO-252AE)				
Diode variation	Common cathode				

#### **FEATURES**

- Very low profile typical height of 1.3 mm
- · Ideal for automated placement
- · Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both industry and automotive applications.

#### **MECHANICAL DATA**

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102, M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	SE60PWBC	SE60PWDC	SE60PWGC	SE60PWJC	UNIT	
Device marking code		SE60PWBC	SE60PWDC	SE60PWGC	SE60PWJC		
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	200	400	600	V	
Maximum average forward rectified current per device		6				A	
(fig. 1) per diode	I <sub>F(AV)</sub> (1)	3					
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	42				А	
Peak forward surge current 1 ms square wave on rated loa	d	80			Α		
Operating junction and storage temperature range		-55 to +175				°C	

#### Notes

(1) With infinite heatsink



www.vishay.com

# Vishay General Semiconductor

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum Instantaneous forward voltage	I <sub>F</sub> = 1.5 A	- T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.94	-	V
	$I_F = 3.0 \text{ A}$			1.03	1.1	
	I <sub>F</sub> = 1.5 A	- T <sub>A</sub> = 125 °C		0.84	-	
	I <sub>F</sub> = 3.0 A			0.94	1.01	
Reverse current	Rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	10	
neverse current	$T_A = 125 ^{\circ}\text{C}$	'R`'	12	150	μΑ	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t <sub>rr</sub>	1200	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	22	-	pF

#### **Notes**

 $^{(1)}$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width  $\leq$  40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER SYMBOL SE60PWBC SE60PWGC SE60PWJC U				UNIT		
Typical thermal resistance per device	R <sub>0</sub> JA (1)(2)	63				°C/W
Typical trieffial resistance per device	R <sub>0JM</sub> (3)	2.3				C/VV

#### **Notes**

- (1) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- (2) Free air, mounted on recommended copper pad area; thermal resistance R<sub>θJA</sub> junction to ambient
- (3) Mounted on infinite heat sink; thermal resistance R<sub>0JM</sub> junction-to-mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T <sub>A</sub> = 25 $^{\circ}$ C unless otherwise noted)						
STANDARD TEST TYPE TEST CONDITIONS SYMBOL CLASS				VALUE		
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 k $\Omega$	V <sub>C</sub>	НЗВ	> 8 kV	

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SE60PWJC-M3/I	0.20	1	4500	13" diameter plastic tape and reel		
SE60PWJCHM3/I (1)	0.20		4500	13" diameter plastic tape and reel		

#### Note

(1) AEC-Q101 qualified

# Vishay General Semiconductor

### **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

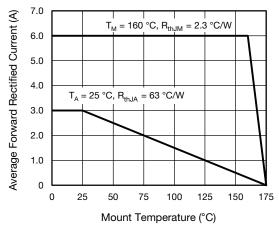


Fig. 1 - Maximum Forward Current Derating Curve

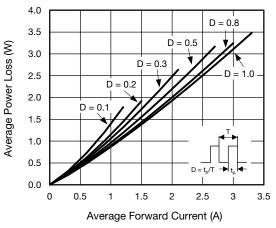


Fig. 2 - Forward Power Loss Characteristics

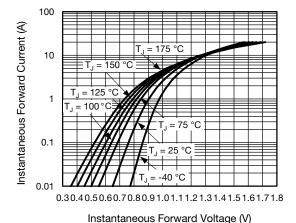


Fig. 3 - Typical Instantaneous Forward Characteristics

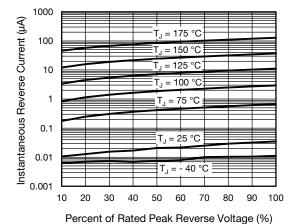


Fig. 4 - Typical Reverse Leakage Characteristics

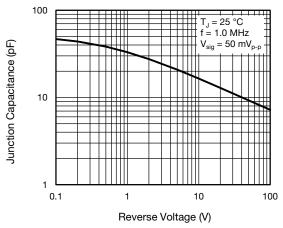


Fig. 5 - Typical Junction Capacitance

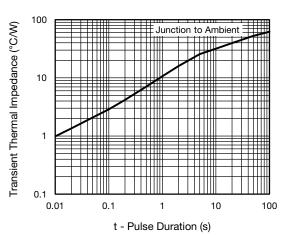


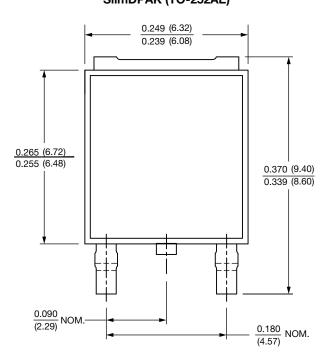
Fig. 6 - Typical Transient Thermal Impedance

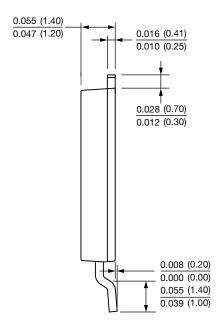


Vishay General Semiconductor

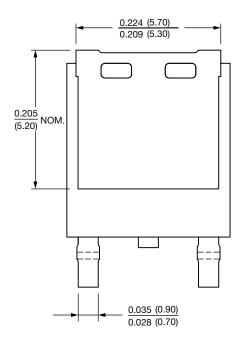
### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

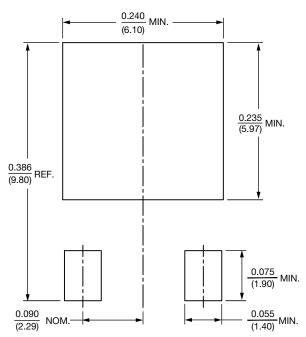
## SlimDPAK (TO-252AE)





#### **Mounting Pad Layout**







## **Legal Disclaimer Notice**

Vishay

### **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.